



1.0 **Features**

- Generates up to nine clock outputs, grouped as 4-4-1 from one reference clock input
- Pin enable/disable of two banks of four clocks
- Auto power-down shuts off PLL, brings outputs low in the absence of any REF input
- Tracking skew < 200ps (spread-spectrum tolerant)
- Input-to-output propagation delay < 200ps
- Available in a 16-pin 0.150" SOIC

Table 1: Clock Enable Configuration

CON	TROL		0.		
S2	S1	CLK_A1:4	CLK_B1:4	CLK_FB	Source
0	0	Tristate	Tristate	Driven	PLL
0	1	Driven	Tristate	Driven	PLL
1	0	Driven	Driven	Driven	REF
1	1	Driven	Driven	Driven	PLL/

Table 2: Pin Descriptions

Key: DI = Digital Input; DI U = Input with Internal Pull-Up; DI $_{D}$ = Input with Internal Pull-Down; DIO = Digital Input/Output; DO = Digital Output; P = Power/Ground; # = Active-low pin

PIN	TYPE	NAME	DESCRIPTION				
2	(DOD)	CLK_A1	Clock output				
3	DO _D	CLK_A2	Clock output	Bank A			
14	DOD	CLK_A3	Clock output	Dalik A			
15	DO _D	CLK_A4	Clock output				
6	DO _D	CLK_B1	Clock output				
7	DO _D	CLK_B2	Clock output	Bank B			
10	DO_D	CLK_B3	Clock output	Dalik D			
11	DO_D	CLK_B4	Clock output				
16	DO _D	CLK_FB	Clock output that also provides an internal feedback connection to the PLL				
1	DI_D	REF	Reference clock input				
8, 9	DI ^U	S2, S1	Two select inputs that enable and disable the clock outputs, and enable or bypass the PLL				
4, 13	Р	VDD	3.3V power supply				
5, 12	Р	VSS	Ground				

Figure 1: Block Diagram

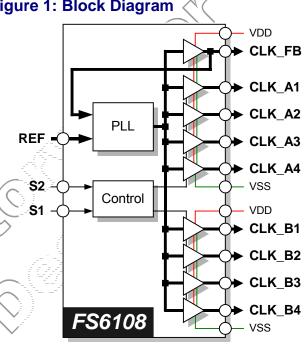
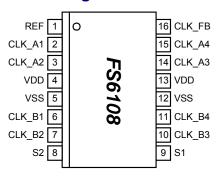


Figure 2: Pin Configuration



American Microsystems, Inc. reserves the right to change the detail specifications as may be required to permit improvements in the design of its products.



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2.0 Electrical Specifications

Table 3: Absolute Maximum Ratings

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These conditions represent a stress rating only, and functional operation of the device at these or any other conditions above the operational limits noted in this specification is not implied. Exposure to maximum rating conditions for extended conditions may affect device performance, functionality, and reliability.

PARAMETER	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage (V _{SS} = ground)	V _{DO}	V _{SS} -0.5	7	V
Input Voltage, dc	VI	V _{SS} -0.5	V _{DD} +0.5	V
Output Voltage, dc	(V ₀)	V _{SS} -0.5	V _{DD} +0.5	V
Input Clamp Current, dc (V _I < 0 or V _I > V _{DD})	P _{IK}	-50	50	mA
Output Clamp Current, dc (V _I < 0 or V _I > V _{DD})	I _{OK}	(-50)	50	mA
Storage Temperature Range (non-condensing)	Ts	-65	150	°C
Ambient Temperature Range, Under Bias	T ₄	-55	125	°C
Junction Temperature	Ty		125	°C
Lead Temperature (soldering, 10s)	\sim ($\langle \langle \rangle \rangle$		260	°C
Input Static Discharge Voltage Protection (MIL-STD 883E, Method 3015.7)			2	kV



CAUTION: ELECTROSTATIC SENSITIVE DEVICE

Permanent damage resulting in a loss of functionality or performance may occur if this device is subjected to a high-energy electrostatic discharge.

Table 4: Operating Conditions

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	MIN.	TYP.	MAX.	UNITS
Supply Voltage	V _{DD}		3.0	3.3	3.6	V
Operating Temperature Range	TA		0		70	°C
Load Capacitance	CL	CLK_A1:4, CLK_B1:4, CLK_FB			30	pF
Reference Frequency Range	f _{REF}		10		66.67	MHz



Table 5: DC Electrical Specifications

Unless otherwise stated, all power supplies = 3.6V, no load on any output, and ambient temperature range T_A = 0°C to 70°C. Parameters denoted with an asterisk (*) represent nominal characterization data and are not currently production tested to any specific limits. MIN and MAX characterization data are \pm 3 σ from typical. Negative currents indicate current flows out of the device.

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	MIN	TYP.	MAX.	UNITS
Overall						
Supply Current, Dynamic, with Loaded Outputs	I _{DD}	f _{REF} = 66.6MHz; all supplies = 3.465V		36		mA
Supply Current, Static	I _{DDs}	REF stopped either high or low	6	20		μΑ
Reference Input (REF)				2)		
High-Level Input Voltage	V _{IH}	_(()	(2.0)		V _{DD} +0.3	V
Low-Level Input Voltage	V _{IL}		V _{SS} -0.3		0.8	V
High-Level Input Current (pull-down)	I _{IH}	V _{IH} = 3.3V)V)	25		μΑ
Low-Level Input Current	I _{IL}		-1		1	μΑ
Digital Inputs (S1, S2)						
High-Level Input Voltage	V _{IH}		2.0		V _{DD} +0.3	V
Low-Level Input Voltage	V _{IL}	(0)	V _{SS} -0.3		0.8	V
High-Level Input Current	I _{IH}		-1		1	μΑ
Low-Level Input Current (pull-up)		V _{IL} = 0V		-30		μΑ
Clock Outputs (CLK_A1:4, CLK_B1:4, C	LK_FB)					
High Level Output Source Current	loH	V _O = 2.4V	-7	-65		mA
Low Level Output Sink Current	V) I _{OL}	V _O = 0:4V		26	7	mA
Output Impedance	Z _{OL}	Measured at 1.5V, output driving low		20		Ω
Output Impedance	Z _{OH}	Measured at 1.5V, output driving high		18		52
Tristate Output Current	loz	>	-10		10	μΑ
Short Circuit Output Source Current	Iosh	V_{DD} = 3.6V, V_{O} = 0V; shorted for 30s, max.		-96		mA
Short Circuit Output Sink Current	I _{OSL}	$V_{DD} = V_O = 3.6V$, shorted for 30s, max.		90		mA

Table 6: AC Timing Specifications

Unless otherwise stated, all power supplies = 3.6V, no load on any output, and ambient temperature range T_A = 25°C. Parameters denoted with an asterisk (*) represent nominal characterization data and are not currently production tested to any specific limits. MIN and MAX characterization data are \pm 3 σ from typical.

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION		TYP.	MAX.	UNITS	
Clock Outputs (CLK_A1:4, CLK_B1:4, CLK_FB)							
Duty Cycle *	d _t	Ratio of high pulse width to one clock period, measured at 1.5V	45		55	%	
Jitter, Period (peak-peak) *	$t_{j(\DeltaP)}$	From rising edge to rising edge at 1.5V, C _L =30pF		75		ps	
Skew, Tracking	t _{sk(tr)}	±0.5% non-linear (Lexmark) profile @ 31.5kHz		190		ps	
Skew, Bank Output-Bank Output	t _{sk(b)}	CLK_A2 to CLK_B1; C _L =30pF		250		ps	
PLL Reference Zero Delay	tφ	REF to CLK_FB		150		ps	
Rise Time *	t _r	Measured @ 0.8V – 2.0V; C _L =30pF		1.6		ns	
Fall Time *	t _f	Measured @ 2.0V - 0.8V; C _L =30pF		1.0		ns	

IS09001

FS6108-01

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3.0 Package Information

Table 7: 16-pin SOIC (0.150") Package Dimensions

	DIMENSIONS						
	INC	HES	MILLIMETERS				
	MIN.	MAX.	MIN.	MAX.			
Α	0.061	0.068	1.55	1.73			
A1	0.004	0.0098	0.102	0.249			
A2	0.055	0.061	1.40	1.55			
В	0.013	0.019	0.33	0.49			
С	0.0075	0.0098	0.191	0.249			
D	0.386	0.393	9.80	9.98			
Е	0.150	0.157	3.81	3.99			
е	0.050 BSC		1.27	BSC			
Н	0.230	0.244	5.84	6.20			
h	0.010	0.016	0.25	0.41			
L	0.016	0.035	0.41	0.89			
Θ	0°	8°	0°	8°			

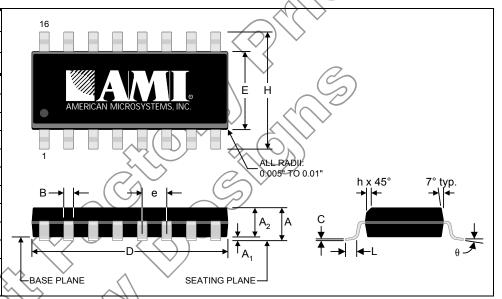


Table 8: 16-pin SOIC (0.150") Package Characteristics

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	TYP.	UNITS
Thermal Impedance, Junction to Free-Air	Θ_{JA}	Air flow = 0 m/s	109	°C/W
Lead Inductance, Self	,	Corner lead	4.0	nH
Lead inductance, Seil	L ₁₁	Center lead	3.0	ПП
Lead Inductance, Mutual	L ₁₂	Any lead to any adjacent lead	0.4	nH
Lead Capacitance, Bulk	C ₁₁	Any lead to V _{SS}	0.5	pF



4.0 Ordering Information

Table 9: Device Ordering Codes

DEVICE NUMBER	ORDERING CODE	PACKAGE TYPE	OPERATING TEMPERATURE RANGE	SHIPPING CONFIGURATION
FS6108-01	12055-801	16-pin (0.150") SOIC	0°C to 70°C (Commercial)	Tape and Reel
F30100-01	12055-801	16-pin (0.150") SOIC	0°C to 70°C (Commercial)	Tubes



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